MA2Z785 (MA785)

Silicon epitaxial planar type

For super high speed switching For small current rectification

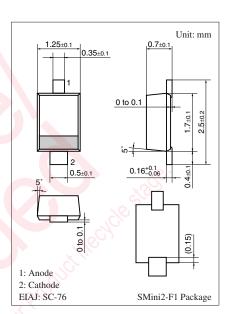
Features

- High-density mounting is possible
- Forward current (Average) $I_{F(AV)} = 100$ mA rectification is possible
- Optimum for high frequency rectification because of its short reverse recovery time t_{rr}
- Low forward voltage V_F and good rectification efficiency
- Reverse voltage $V_R = 50 \text{ V}$ is guaranteed

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	V_R	50	V
Repetitive peak reverse voltage	V _{RRM}	50	V
Peak forward current	I_{FM}	300	mA
Forward current (Average)	I _{F(AV)}	100	mA
Non-repetitive peak forward surge current *	I_{FSM}	1	A
Junction temperature	T _j	125	°C
Storage temperature	T _{stg}	-55 to +125	oc oc

Note) *: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

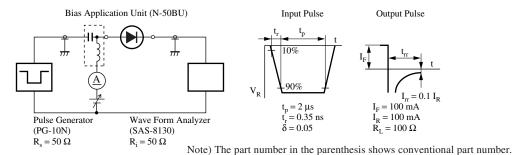


Marking Symbol: 2E

■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

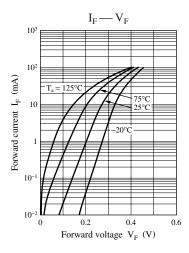
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F}$	$I_F = 100 \text{ mA}$	00)		0.55	V
Reverse current	I_R	$V_R = 50 \text{ V}$	0.7		30	μΑ
Terminal capacitance	C_{t}	$V_R = 0 V, f = 1 MHz$		25		pF
Reverse recovery time *	t _{rr}	$I_F = I_R = 100 \text{ mA}$		3.0		ns
* C		$I_{rr} = 0.1 I_R, R_L = 100 \Omega$				

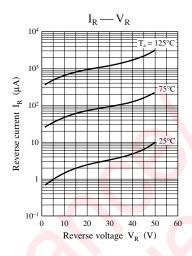
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. Absolute frequency of input and output is 200 MHz.
- 4. *: t_{rr} measurement circuit

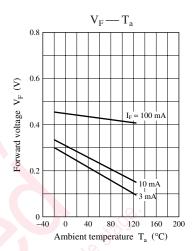


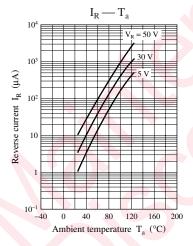
Publication date: April 2004 SKH00038BED 1

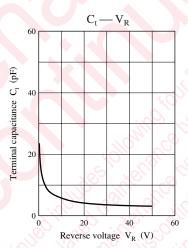
Panasonic











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